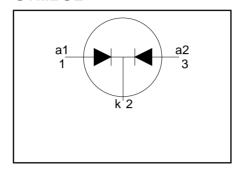
### BYQ28F, BYQ28EX series

### **FEATURES**

- Low forward volt drop
- Fast switching
- · Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
- · Isolated mounting tab

### **SYMBOL**



### QUICK REFERENCE DATA

$$V_{R} = 150 \text{ V} / 200 \text{ V}$$
 $V_{F} \le 0.895 \text{ V}$ 
 $I_{O(AV)} = 10 \text{ A}$ 
 $I_{RRM} = 0.2 \text{ A}$ 
 $t_{rr} \le 25 \text{ ns}$ 

### **GENERAL DESCRIPTION**

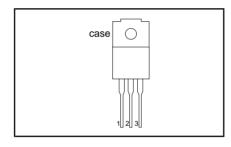
Dual, ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYQ28F series is supplied in the SOT186 package. The BYQ28EX series is supplied in the SOT186A package.

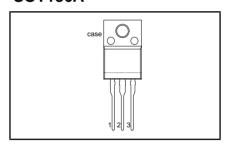
### **PINNING**

PIN	DESCRIPTION		
1	anode 1 (a)		
2	cathode (k)		
3	anode 2 (a)		
tab	isolated		

### **SOT186**



### SOT186A



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	N. MAX.		UNIT
V <sub>RRM</sub>	Peak repetitive reverse voltage	BYQ28F / BYQ28EX	-	<b>-150</b> 150 150	<b>-200</b> 200 200	V
$V_{RWM}$	Crest working reverse voltage Continuous reverse voltage	$T_{hs} \le 148^{\circ}C$	-	150	200	V
I <sub>O(AV)</sub>		square wave $\delta = 0.5$ ; $T_{hs} \le 92$ °C	-	1	0	Α
I <sub>FRM</sub>	Repetitive peak forward current per diode	$t = 25 \mu s; \delta = 0.5;$ $T_{hs} \le 92 ^{\circ}C$	-	1	0	Α
I <sub>FSM</sub>	Non-repetitive peak forward current per diode	t = 10 ms t = 8.3 ms sinusoidal; with reapplied V <sub>RWM(max)</sub>	-	5 5		A A
I <sub>RRM</sub>	Repetitive peak reverse current per diode	$t_{p} = 2 \mu s; \delta = 0.001$	-	0	.2	Α
I <sub>RSM</sub>	Non-repetitive peak reverse current per diode	$t_{p} = 100 \ \mu s$	-	0	.2	А
$egin{array}{c} T_{stg} \ T_{j} \end{array}$	Storage temperature Operating junction temperature		-40 -		50 50	°C

<sup>1</sup> Neglecting switching and reverse current losses

BYQ28F, BYQ28EX series

### **ESD LIMITING VALUE**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>C</sub>	l a	Human body model; C = 250 pF; R = 1.5 kΩ	-	8	kV

### **ISOLATION LIMITING VALUE & CHARACTERISTIC**

T<sub>hs</sub> = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>isol</sub>	Peak isolation voltage from all terminals to external heatsink	SOT186 package; R.H. ≤ 65%; clean and dustfree	1	-	1500	V
V <sub>isol</sub>	R.M.S. isolation voltage from all terminals to external heatsink	SOT186A package; f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	<u>-</u>	-	2500	V
C <sub>isol</sub>	Capacitance from pin 2 to external heatsink	f = 1 MHz	-	10	-	pF

### THERMAL RESISTANCES

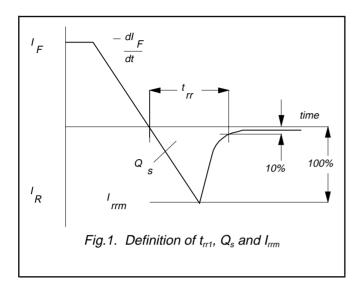
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th j-hs}$ $R_{th j-a}$	heatsink	with heatsink compound without heatsink compound in free air	1 1 1	- - 55	5.7 6.7 -	K/W K/W K/W

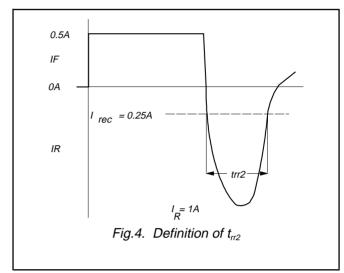
### **ELECTRICAL CHARACTERISTICS**

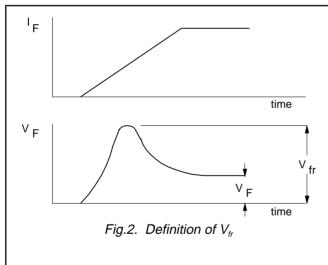
characteristics are per diode at T<sub>i</sub> = 25 °C unless otherwise stated

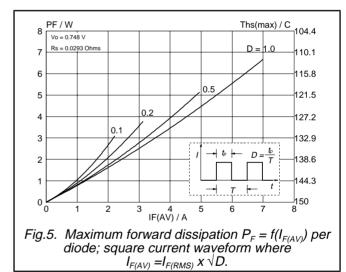
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage	$I_{\rm F} = 5 \text{ A}; T_{\rm i} = 150 ^{\circ} \text{C}$	•	0.80	0.895	V
'		$I_F = 5 \text{ A}$	-	0.95	1.10	V
		$I_{\rm F} = 10 \text{ A}$	-	1.10	1.25	V
I <sub>R</sub>	Reverse current	$V_R = V_{RWM}$ ; $T_i = 100 ^{\circ}C$	-	0.1	0.2	mΑ
'		$V_R = V_{RWM}$	-	2	10	μΑ
$Q_{\rm s}$	Reverse recovery charge	$ I_F = 2 \text{ A}; V_R \ge 30 \text{ V}; -dI_F/dt = 20 \text{ A/}\mu\text{s} $	-	4	9	'nC
t <sub>rr1</sub>	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$	-	15	25	ns
		$-dI_{F}/dt = 100 A/\mu s$				
t <sub>rr2</sub>	Reverse recovery time	$I_F = 0.5 \text{ A to } I_R = 1 \text{ A}, I_{rec} = 0.25 \text{ A}$	-	10	20	ns
11	Peak reverse recovery current	$ I_F = 5 \text{ A}; V_R \ge 30 \text{ V}; -dI_F/dt = 50 \text{ A/}\mu\text{s}$	-	0.5	0.7	Α
$V_{fr}$	Forward recovery voltage	$I_F = 1 \text{ A}; dI_F/dt = 10 \text{ A/}\mu\text{s}$	-	1	-	V

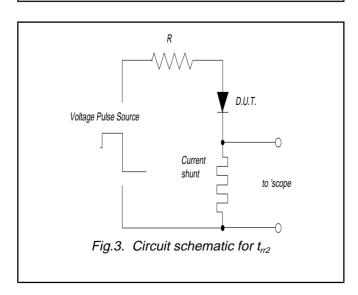
## BYQ28F, BYQ28EX series











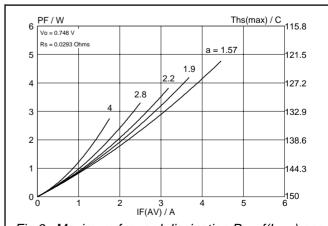
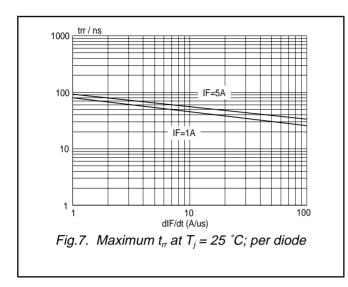
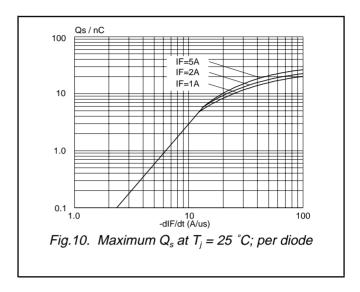
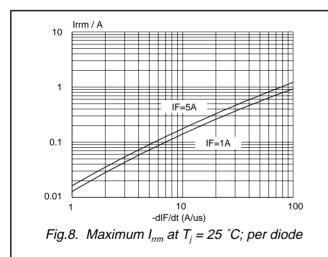


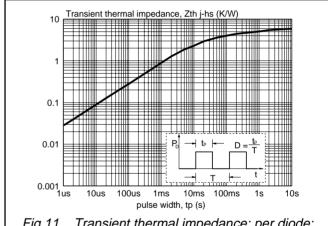
Fig.6. Maximum forward dissipation  $P_F = f(I_{F(AV)})$  per diode; sinusoidal current waveform where a = form factor  $= I_{F(RMS)} / I_{F(AV)}$ .

### BYQ28F, BYQ28EX series









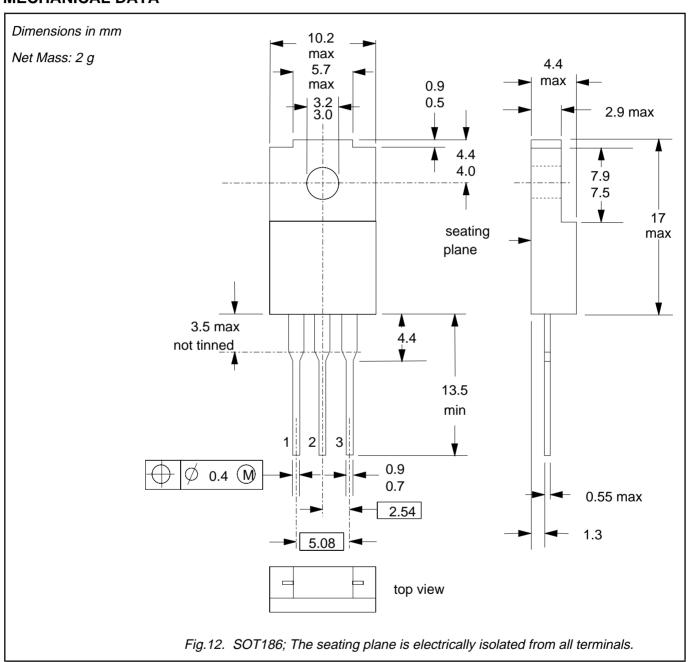
15 |F/A | Tj=150C | Tj=25C | T

Fig.11. Transient thermal impedance; per diode;  $Z_{th j - hs} = f(t_p)$ .

Fig.9. Typical and maximum forward characteristic  $I_F = f(V_F)$ ; parameter  $T_j$ 

BYQ28F, BYQ28EX series

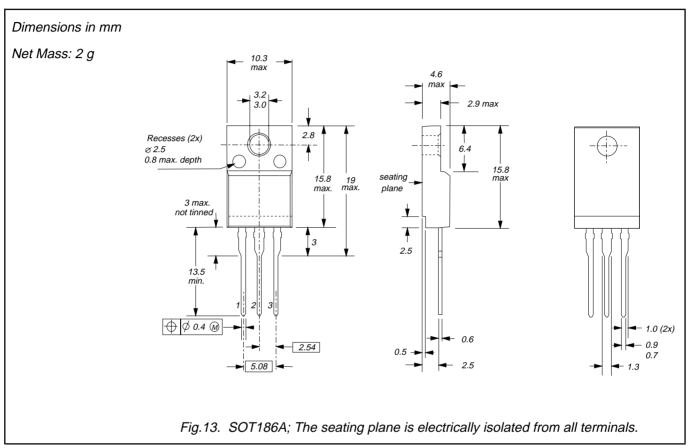
### **MECHANICAL DATA**



- Refer to mounting instructions for F-pack envelopes.
   Epoxy meets UL94 V0 at 1/8".

BYQ28F, BYQ28EX series

### **MECHANICAL DATA**



- Notes
  1. Refer to mounting instructions for F-pack envelopes.
  2. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

## Rectifier diodes ultrafast, rugged

BYQ28F, BYQ28EX series

#### **DEFINITIONS**

Data sheet status				
Objective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

### © Philips Electronics N.V. 1998

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.